UNION OPTRONICS CORP.

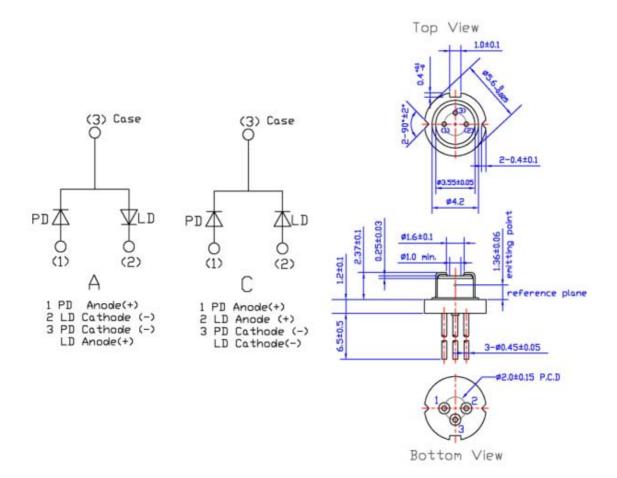
650nm Laser Diode for DVD U-LD-651070A/C-preliminary

Specifications

(1) Device: Laser Diode

(2) Structure: TO-18(ϕ 5.6mm), With Pb free glass cap, PD

External dimensions(Unit: mm)



Absolute Maximum Ratings

$^{\prime\prime}$	$\Gamma_{\rm C}$ -25	Ϋ́	1
()	LC-23	\cup	

Parameter	Symbols	Ratings	Units
Optical Output	Po	12	mW
LD Reverse Voltage	$V_{R(LD)}$	2	V
PD Reverse Voltage	$V_{R(PD)}$	30	V
Operation Temperature	Top	-10~+70	$^{\circ}\mathbb{C}$
Storage Temperature	Tstg	-40~+85	$^{\circ}\!\mathbb{C}$

友嘉科技股份有限公司

桃園縣楊梅鎭3鄰高獅路156號

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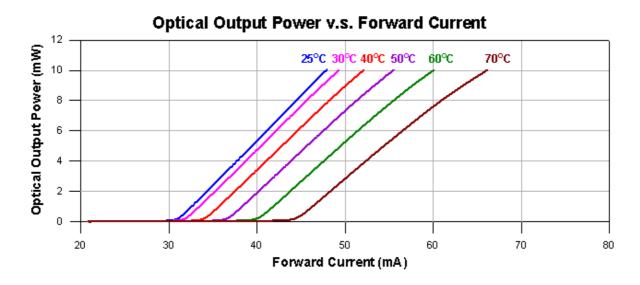
No.156, Gaoshih Rd., Yangmei Township, Taoyuan County 326, Taiwan (R.O.C.)

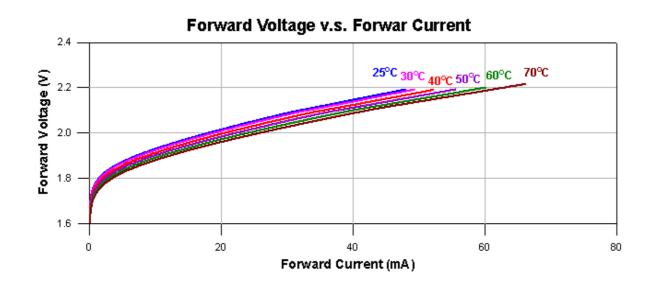
TEL: 886-3-485-2687 FAX: 886-3-475-4378

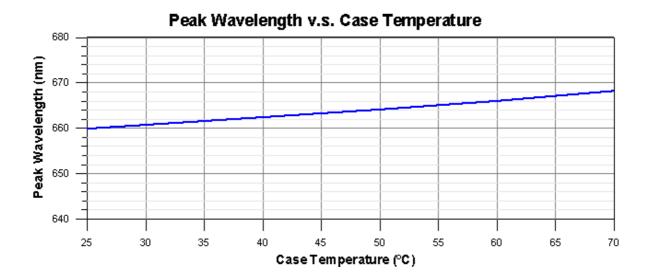
E-mail: sales@uocnet.com Ver.3 2009/03

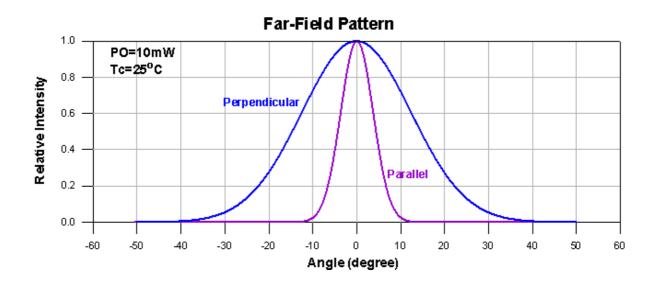
Electrical and Optical Characteristics					(Tc=25 C)			
Parameter		Symbols	Conditions	Min.	Тур.	Max.	Units	
Threshold Current		Ith	-	-	30	35	mA	
Operation Current		Iop	Po=10mW	-	45	50	mA	
Operation Voltage		Vop	Po=10mW	-	2.2	2.6	Volts	
Slope Efficiency		20	7.5mW-2.5mW	0.4	0.6	0.8	mW/mA	
		η	I7.5mW-I2.5mW	V.4				
Monitor Current		Im	Po=10mW	0.2	0.3	0.5	mA	
Beam Divergence	Parallel	θ //	Po=10mW	7	9	11	deg.	
(FWHM)	Perpendicular	$ heta \perp$	Po=10mW	25	30	35	deg.	
Lasing Wavelength		λ	Po=10mW	650	660	670	nm	

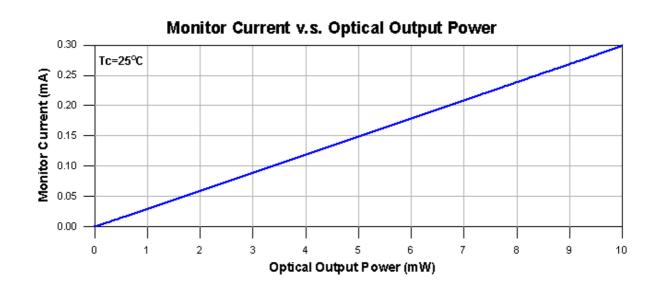
Typical characteristic curves

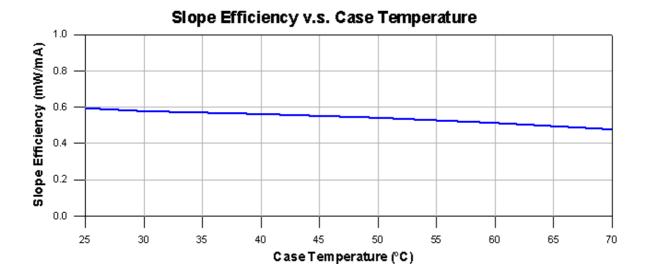


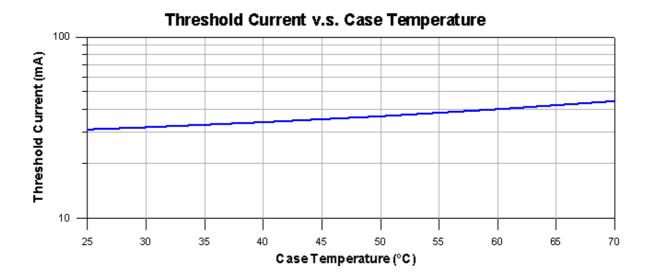












Precautions

QUALITY ASSURANCE

After any processing of laser chip or laser diode TO-CAN (LD) by the customer, the performance, yield and reliability of the product, in which the chip or LD is applied, are subject to change due to customer's handling, assembly, testing, and processing. Because laser chip and LD are strongly affected by environmental conditions, physical stress, and chemical stresses imposed by customer that are not in Union Optronics Corp. (UOC) control and hence no guarantee on the characteristics and the reliability at all after the shipment. Also, UOC does not have any responsibility for field failures in a customer product. When attaching a heat sink to laser chip or LD, be careful not to apply excessive force to the device in the process.

SAFETY PRECAUTIONS

Although Union Optronics Corp. (UOC) keeps improving quality and reliability of its laser chip and laser diode TO-CAN (LD), semiconductor devices in general can malfunction or fail due to their intrinsic characteristics. Hence, it is required that the customer's products are designed with full regard to safety by incorporating the redundancy, fire prevention, error prevention so that any problems or error with UOC laser chip or LD does not cause any accidents resulting in injury, death, fire, property damage, economic damage, or environmental damage. In case customer wants to use UOC laser chip or LD in the systems requiring high safety, customer is requested to confirm safety of entire systems with customer's own testing.

SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.

The information provided by Union Optronics Corp. (UOC), including but not limited to technical specifications, recommendations, and application notes relating to laser chip or laser diode TO-CAN (LD) is believed to be reliable and accurate and is subject to change without notice. UOC reserves the right to change its assembly, test, design, form, specification, control, or function without notice.